

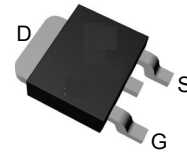
Features

- 40V/80A,
 $R_{DS(ON)} = 4.1m\Omega(\text{typ.}) @ V_{GS} = 10V$
 $R_{DS(ON)} = 5.4m\Omega(\text{typ.}) @ V_{GS} = 4.5V$
- 100% UIS + R_g Tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

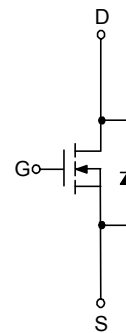
Applications

- SMPS Synchronous Rectification.
- Load Switch.
- DC-DC Conversion.

Pin Description



Top View of TO-252



N-Channel MOSFET

Part.no	Marking	Package	PCS/Reel	PCS/CTN
RSTD4080YD	RSTD4080	TO-252-2	2500	30000

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter		Rating	Unit
Common Ratings				
V _{DSS}	Drain-Source Voltage		40	V
V _{GSS}	Gate-Source Voltage		±20	
T _J	Maximum Junction Temperature		150	°C
T _{STG}	Storage Temperature Range		-55 to 150	
I _S	Diode Continuous Forward Current	T _C =25°C	80	A
I _D ^a	Continuous Drain Current	T _C =25°C	80	
		T _C =100°C	48	
I _{DM} ^b	Pulsed Drain Current	T _C =25°C	240	
P _D	Maximum Power Dissipation	T _C =25°C	54	W
		T _C =100°C	22	
R _{θJC}	Thermal Resistance-Junction to Case	Steady State	2.3	°C/W
R _{θJA} ^c	Thermal Resistance-Junction to Ambient	t ≤ 10s	17	°C/W
		Steady State	50	
I _{AS} ^d	Avalanche Current, Single pulse	L=0.1mH	72	A
E _{AS} ^d	Avalanche Energy, Single pulse	L=0.1mH	259	mJ

Note a : Max. continue current is limited by bonding wire.

Note b : Pulse width is limited by max. junction temperature.

Note c : Surface mounted on 1in2 pad area, steady state $t=999\text{s}$.

Note d : UIS tested and pulse width limited by maximum junction temperature 150°C (initial temperature $T_J=25^\circ\text{C}$).

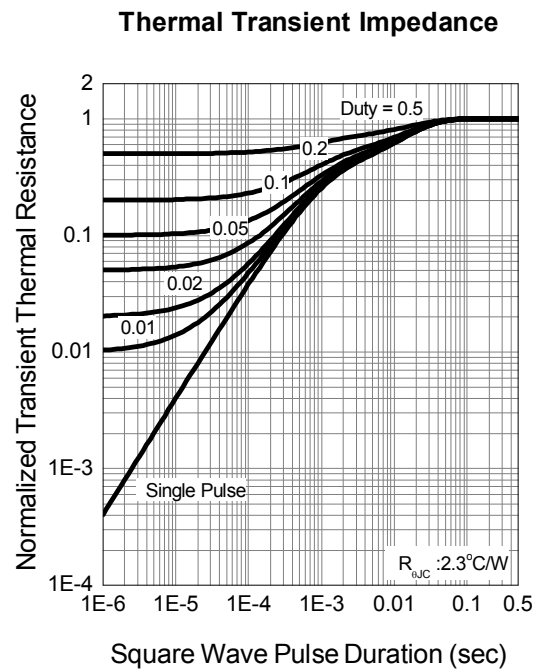
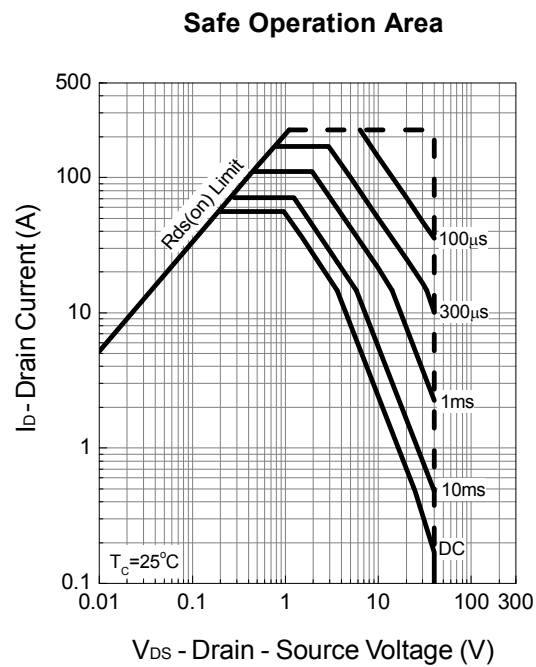
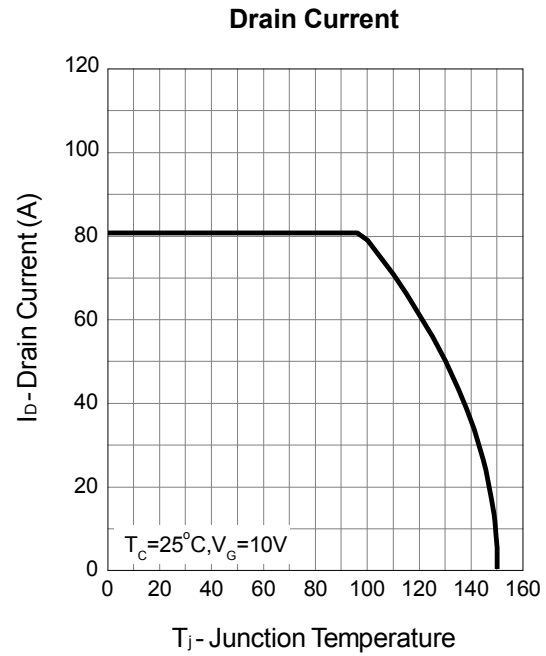
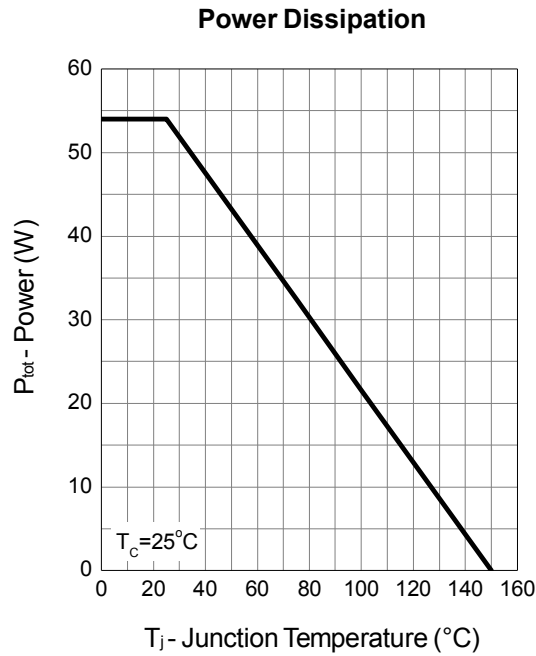
Electrical Characteristics (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	40	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =32V, V _{GS} =0V T _J =85°C	-	-	1 30	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	1.3	1.7	2.5	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
R _{DS(ON)} ^e	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =20A V _{GS} =4.5V, I _{DS} =15A	-	4.1 5.4	5.5 7	mΩ
G _{fs}	Forward Transconductance	V _{DS} =5V, I _{DS} =20A	-	31	-	S
Diode Characteristics						
V _{SD} ^e	Diode Forward Voltage	I _{SD} =20A, V _{GS} =0V	-	0.75	1.1	V
t _{rr}	Reverse Recovery Time	I _{SD} =20A, dI _{SD} /dt=100A/μs	-	28	-	ns
t _a	Charge Time		-	17	-	
t _b	Discharge Time		-	12	-	
Q _{rr}	Reverse Recovery Charge		-	20	-	nC
Dynamic Characteristics ^f						
R _G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	-	1	2	Ω
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =20V, Frequency=1.0MHz	-	1622	-	pF
C _{oss}	Output Capacitance		-	385	-	
C _{rss}	Reverse Transfer Capacitance		-	235	-	
t _{d(ON)}	Turn-on Delay Time	V _{DD} =20V, R _L =20Ω, I _{DS} =1A, V _{GEN} =10V, R _G =6Ω	-	8	-	ns
t _r	Turn-on Rise Time		-	18	-	
t _{d(OFF)}	Turn-off Delay Time		-	24	-	
t _f	Turn-off Fall Time		-	14	-	
Gate Charge Characteristics ^f						
Q _g	Total Gate Charge	V _{DS} =20V, V _{GS} =10V, I _{DS} =20A	-	58	-	nC
Q _g	Total Gate Charge	V _{DS} =20V, V _{GS} =4.5V, I _{DS} =20A	-	40	-	
Q _{gth}	Threshold Gate Charge		-	5	-	
Q _{gs}	Gate-Source Charge		-	9	-	
Q _{gd}	Gate-Drain Charge		-	11	-	

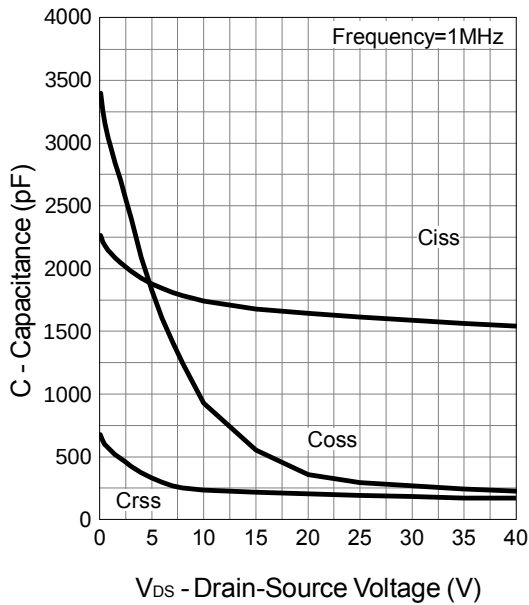
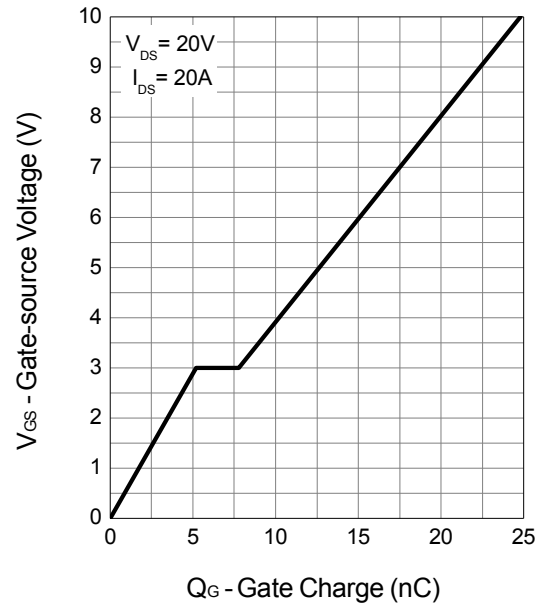
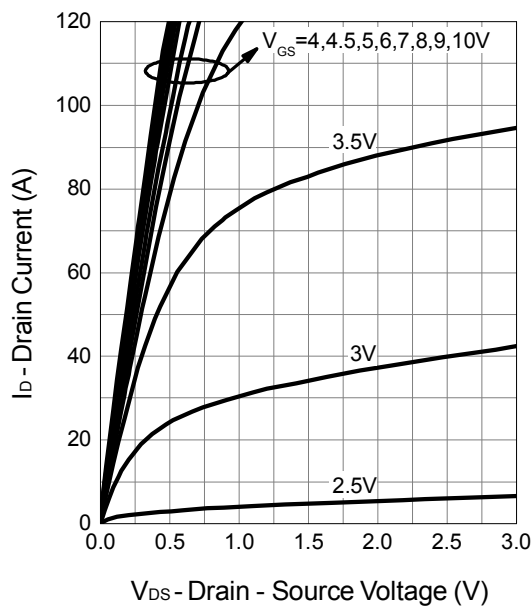
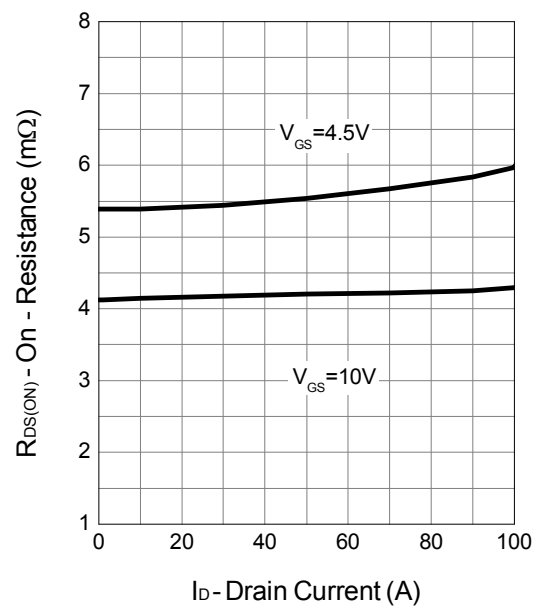
Note e : Pulse test ; pulse width≤300μs, duty cycle≤2%.

Note f : Guaranteed by design, not subject to production testing.

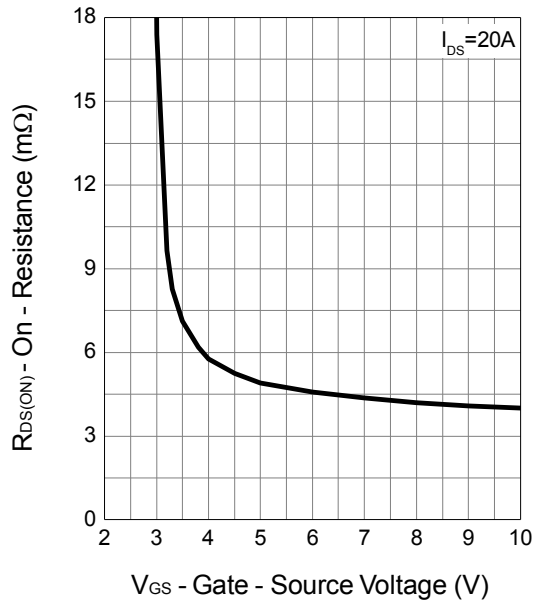
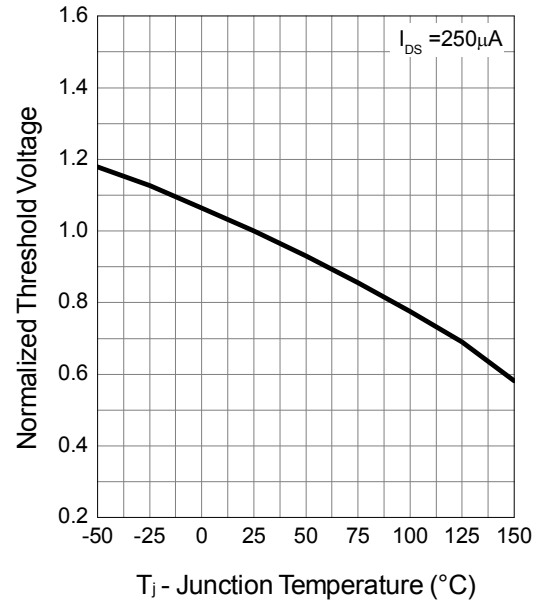
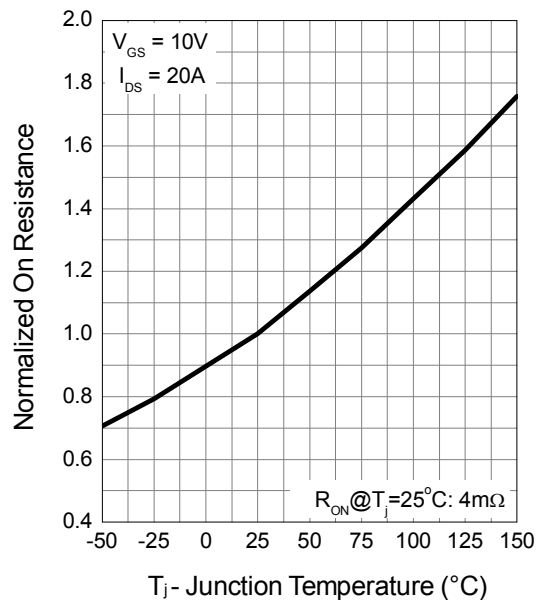
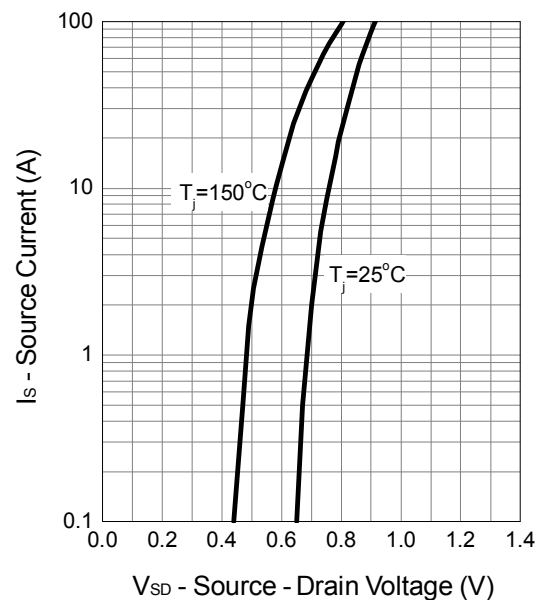
Typical Operating Characteristics



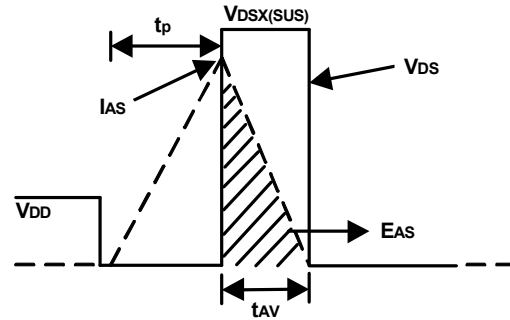
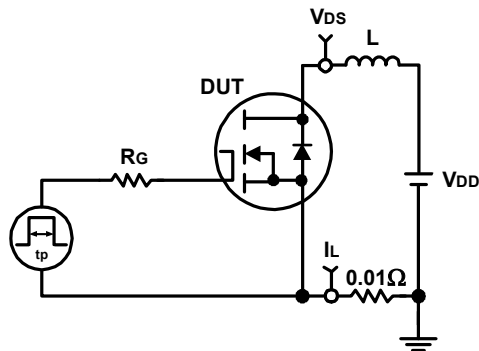
Typical Operating Characteristics (Cont.)

Capacitance

Gate Charge

Output Characteristics

Drain-Source On Resistance


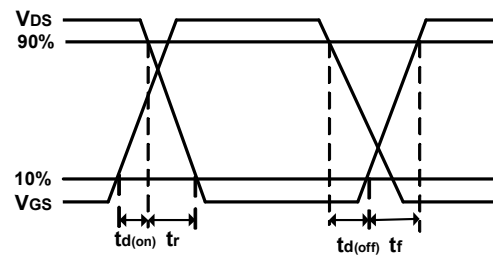
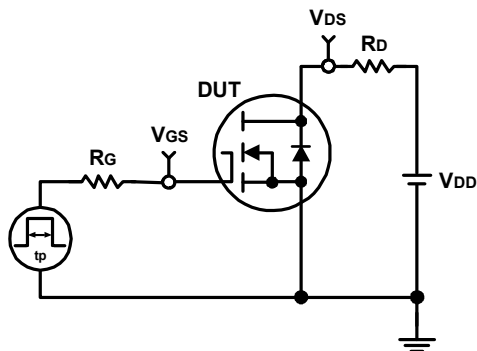
Typical Operating Characteristics (Cont.)

Gate-Source On Resistance

Gate Threshold Voltage

Drain-Source On Resistance

Source-Drain Diode Forward


Avalanche Test Circuit and Waveforms

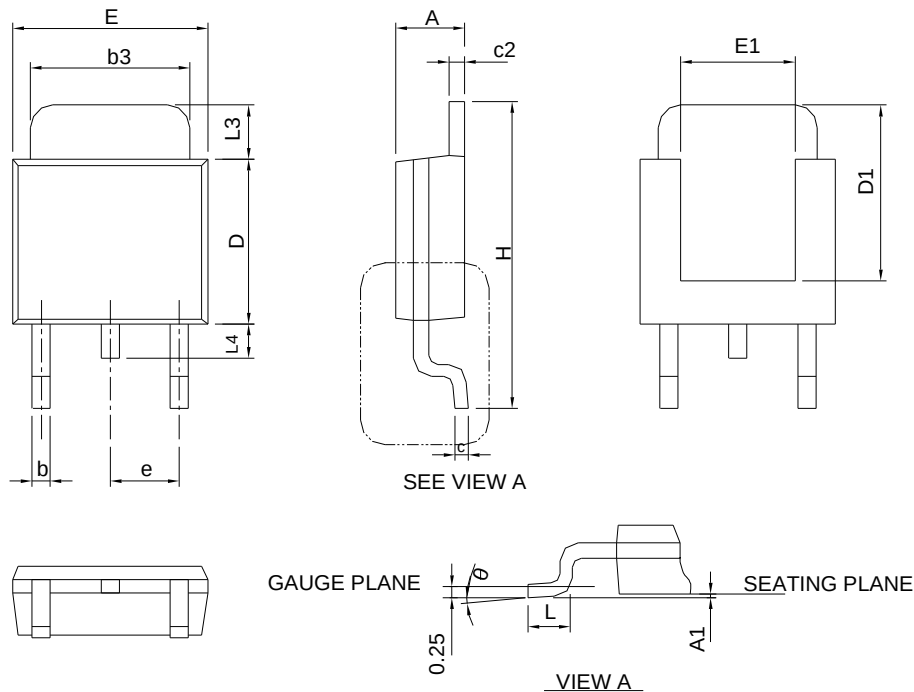


Switching Time Test Circuit and Waveforms



Package Information

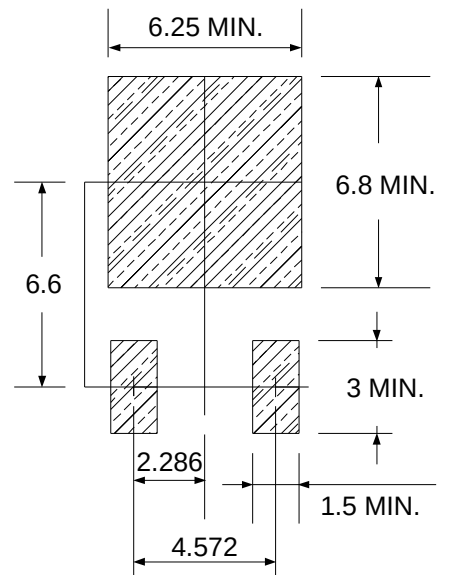
TO-252



SYMBOL	TO-252			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1	-	0.13	-	0.005
b	0.50	0.89	0.020	0.035
b3	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
E	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
e	2.29 BSC		0.090 BSC	
H	9.40	10.41	0.370	0.410
L	0.90	1.78	0.035	0.070
L3	0.89	2.03	0.035	0.080
L4	-	1.02	-	0.040
θ	0°	8°	0°	8°

Note : Follow JEDEC TO-252-2 .

RECOMMENDED LAND PATTERN



UNIT: mm